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MBRP20045CT

POWERTAP II Switch-mode Power Rectifier

This state−of−the−art device uses the Schottky Barrier principle with a platinum barrier metal.

Features

- Dual Diode Construction; May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Pb−Free Package is Available*

Mechanical Characteristics

- Case: Epoxy, Molded with Metal Heatsink Base
- Weight: 80 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25−40 lb−in Max
- Base Plate Torques: See Procedure Given in the Package Outline Section

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	V
Average Rectified Forward Current (Rated V_R, T_C = 140°C) Per Leg Per Device	$I_{F(AV)}$	100 200	A
Peak Repetitive Forward Current, (Rated V_R, Square Wave, 20 kHz, T_C = 140°C) Per Leg	I_{FRM}	200	A
Non−Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	1500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Leg	I_{RRM}	2.0	A
Storage Temperature Range	T_{stg}	−55 to +150	°C
Operating Junction Temperature	T_J	−55 to +150	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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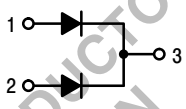
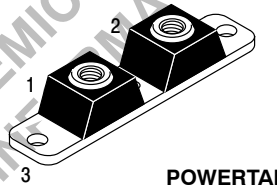
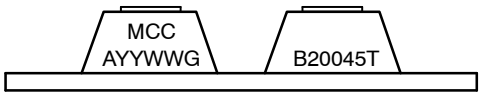
SCHOTTKY BARRIER RECTIFIER 200 AMPERES, 45 VOLTS





POWERTAP II
CASE 357C
PLASTIC

MARKING DIAGRAM



B20045T = Specific Device Code
MCC = Mold Compound Code
A = Assembly Location
YY = Year
WW = York Week
G = Pb−Free Package

ORDERING INFORMATION

Device	Package	Shipping
MBRP20045CT	POWERTAP II	25 Units/Tray
MBRP20045CTG	POWERTAP II (Pb−Free)	25 Units/Tray

THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	0.6	°C/W

ELECTRICAL CHARACTERISTICS (Per Leg)

Instantaneous Forward Voltage (Note 1) (i_F = 200 Amps, T_J = 25°C) (i_F = 200 Amps, T_J = 125°C)	v_F	 0.89 0.78	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T_J = 125°C) (Rated dc Voltage, T_J = 25°C)	i_R	 50 0.5	mA

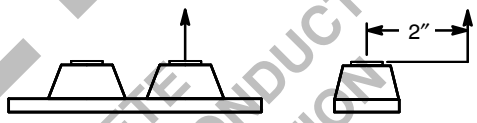
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25−40 in-lb max
Mounting Torque — Outside Holes:	30−40 in-lb max
Mounting Torque — Center Hole:	8−10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

POWERTAP MECHANICAL DATA
APPLIES OVER OPERATING TEMPERATURE



Vertical Pull
250 lbs. max

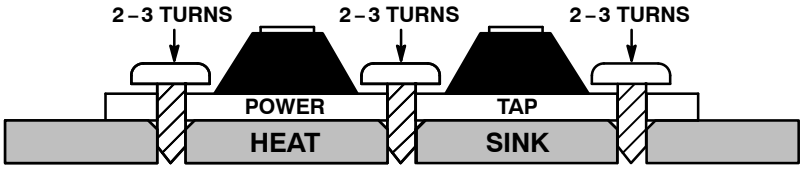
2 in. Lever Pull
50 lbs. max

Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

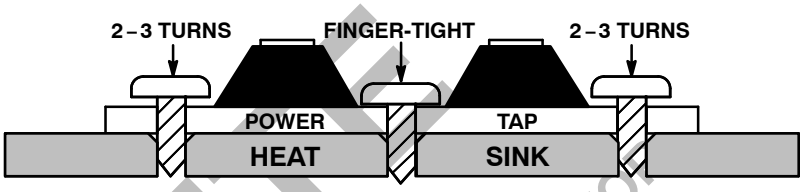
MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

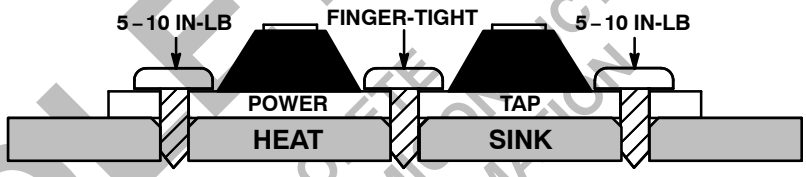
STEP 1:
Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).



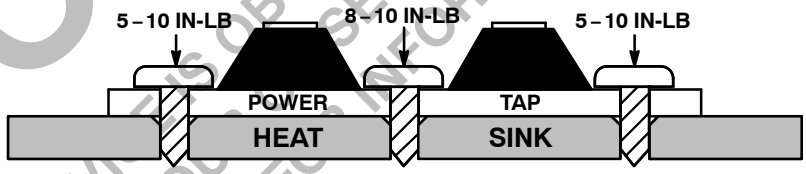
STEP 2:
Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.



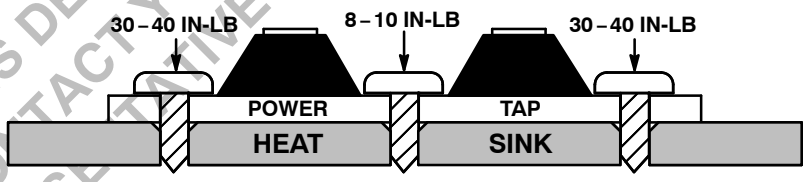
STEP 3:
Tighten each of the end bolts between 5 to 10 in-lb.



STEP 4:
Tighten the center bolt between 8 to 10 in-lb.



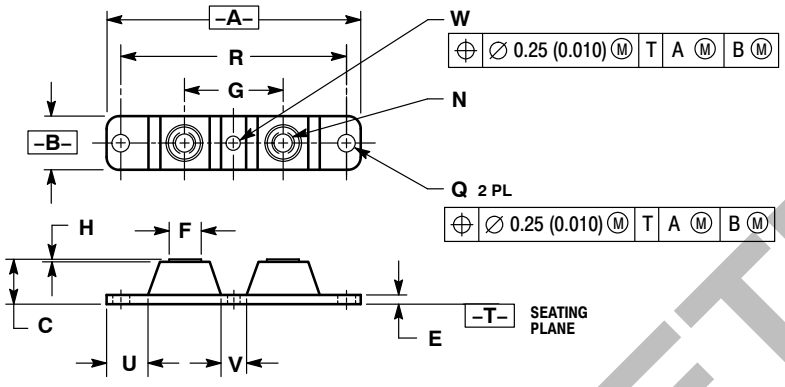
STEP 5:
Finally, tighten the end bolts between 30 to 40 in-lb.



MBRP20045CT

PACKAGE DIMENSIONS

CASE 357C−03
POWERTAP
PLASTIC PACKAGE
ISSUE E



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. TERMINAL PENETRATION: 5.97 (0.235) MAXIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	3.450	3.635	87.63	92.33
B	0.700	0.810	17.78	20.57
C	0.615	0.640	15.63	16.26
E	0.120	0.130	3.05	3.30
F	0.435	0.445	11.05	11.30
G	1.370	1.380	34.80	35.05
H	0.007	0.030	0.18	0.76
N	1/4−20UNC−2B		1/4−20UNC−2B	
Q	0.270	0.285	6.86	7.23
R	31.50 BSC		80.01 BSC	
U	0.600	0.630	15.24	16.00
V	0.330	0.375	8.39	9.52
W	0.170	0.190	4.32	4.82

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
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